

N-Channel Super Junction Power MOSFET III

General Description

The series of devices use advanced trench gate super junction technology and design to provide excellent R_{DS(ON)} with low gate charge. This super junction MOSFET fits the industry's AC-DC SMPS requirements for PFC, AC/DC power conversion, and industrial power applications.

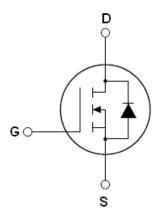
Features

- Optimized body diode reverse recovery performance
- ●Low on-resistance and low conduction losses
- ●Small package
- ●Ultra Low Gate Charge cause lower driving requirements
- ●100% Avalanche Tested
- ROHS compliant

Application

- Power factor correction (PFC)
- Switched mode power supplies(SMPS)
- Uninterruptible Power Supply (UPS)
- LLC Half-bridge

| V _{DS} | 650 | V |
|-------------------------|-----|----|
| R _{DS(ON) MAX} | 180 | mΩ |
| I_D | 21 | A |



Schematic diagram

Package Marking And Ordering Information

| Device | Device Package | Marking |
|-------------|----------------|-------------|
| NCE65TF180 | TO-220 | NCE65TF180 |
| NCE65TF180F | TO-220F | NCE65TF180F |
| NCE65TF180D | TO-263 | NCE65TF180D |







Table 1. Absolute Maximum Ratings ($T_c=25^{\circ}C$)

TO-263 TO-220 TO-220F

| Parameter | Symbol | NCE65TF180 NCE65TF180D | NCE65TF180F | Unit |
|---|-------------------------|---------------------------|-------------|------|
| Drain-Source Voltage (V _{GS} =0V) | V _{DS} | 65 | 50 | V |
| Gate-Source Voltage (V _{DS} =0V), AC (f>1 Hz) | V _G S | ± | 30 | V |
| Continuous Drain Current at T _C =25°C | I _{D (DC)} | 21 | 21* | Α |
| Continuous Drain Current at T _C =100°C | I _{D (DC)} | 13.2 | 13.2* | Α |
| Pulsed drain current (Note 1) | I _{DM (pluse)} | 84 | 84* | Α |
| Maximum Power Dissipation(T _C =25℃) | P _D | 188 | 33.8 | W |
| Derate above 25°C | | 1.5 | 0.27 | w/°C |
| Single pulse avalanche energy (Note 2) | Eas | 441 | | mJ |
| Avalanche current ^(Note 1) | I _{AR} | 10.5 | | Α |
| Repetitive Avalanche energy , t_{AR} limited by T_{Jmax} (Note 1) | E _{AR} | 0 | .7 | mJ |



| Parameter | Symbol | NCE65TF180 NCE65TF180D | NCE65TF180F | Unit |
|---|---------------------|---------------------------|-------------|------|
| Drain Source voltage slope, V _{DS} ≤480 V, | dv/dt | 50 | | V/ns |
| Reverse diode dv/dt, $V_{DS} \leq 480 \text{ V,I}_{SD} < I_{D}$ | dv/dt | 5 | 0 | V/ns |
| Operating Junction and Storage Temperature Range | T_{J} , T_{STG} | -55 | +150 | °C |

^{*} limited by maximum junction temperature

Table 2. Thermal Characteristic

| Parameter | Symbol | NCE65TF180 NCE65TF180D | NCE65TF180F | Unit |
|---|-------------------|---------------------------|-------------|-------|
| Thermal Resistance, Junction-to-Case (Maximum) | R _{thJC} | 0.66 | 3.69 | °C /W |
| Thermal Resistance, Junction-to-Ambient (Maximum) | R _{thJA} | 62.5 | 80 | °C /W |

Table 3. Electrical Characteristics (TA=25°Cunless otherwise noted)

| Parameter | Symbol | mbol Condition | | Тур | Max | Unit |
|--|---------------------|---|-----|----------|------|------|
| On/off states | | | 1 | <u> </u> | ı | |
| Drain-Source Breakdown Voltage | BV _{DSS} | V _{GS} =0V I _D =250μA | 650 | | | V |
| Zero Gate Voltage Drain Current(Tc=25℃) | I _{DSS} | V _{DS} =650V,V _{GS} =0V | | | 2 | μA |
| Zero Gate Voltage Drain Current(Tc=125℃) | I _{DSS} | V _{DS} =650V,V _{GS} =0V | | | 100 | μA |
| Gate-Body Leakage Current | I _{GSS} | V _{GS} =±20V,V _{DS} =0V | | | ±100 | nA |
| Gate Threshold Voltage | $V_{GS(th)}$ | V _{DS} =V _{GS} ,I _D =250μA | 3 | 3.5 | 4 | V |
| Drain-Source On-State Resistance | R _{DS(ON)} | V _{GS} =10V, I _D =10.5A | | 150 | 180 | mΩ |
| Dynamic Characteristics | 1 | | | | • | |
| Forward Transconductance | g FS | V _{DS} = 20V, I _D = 10.5A | | 16 | | S |
| Input Capacitance | C _{lss} | \/ -50\/\/ -0\/ | | 2250 | | PF |
| Output Capacitance | Coss | V_{DS} =50V, V_{GS} =0V, F=1.0MHz | | 83 | | PF |
| Reverse Transfer Capacitance | C _{rss} | F=1.UMHZ | | 1.6 | | PF |
| Total Gate Charge | Q_g | V 400V/1 04A | | 36 | | nC |
| Gate-Source Charge | Q_{gs} | V _{DS} =480V,I _D =21A, | | 14 | | nC |
| Gate-Drain Charge | Q_{gd} | - V _{GS} =10V | | 8.5 | | nC |
| Switching times | | | | | | |
| Turn-on Delay Time | t _{d(on)} | | | 11 | | nS |
| Turn-on Rise Time | t _r | V _{DD} =380V,I _D =11A, | | 6 | | nS |
| Turn-Off Delay Time | t _{d(off)} | $R_G=4\Omega,V_{GS}=10V$ | | 61 | | nS |
| Turn-Off Fall Time | t _f | | | 4.5 | | nS |
| Source- Drain Diode Characteristics | | | | | | |
| Source-drain current(Body Diode) | I _{SD} | T -25°C | | | 21 | Α |
| Pulsed Source-drain current(Body Diode) | I _{SDM} | - T _C =25°C | | | 84 | Α |
| Forward on voltage | V_{SD} | T _j =25°C,I _{SD} =21A,V _{GS} =0V | | 0.9 | 1.3 | V |
| Reverse Recovery Time | t _{rr} | | | 160 | | nS |
| Reverse Recovery Charge | Qrr | T _j =25°C,I _F =11A,di/dt=100A/μs | | 1.4 | | uC |
| Peak Reverse Recovery Current | I _{rrm} | | | 17 | | Α |

Notes 1. Repetitive Rating: Pulse width limited by maximum junction temperature

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 $[\]textbf{2.} \ \, T_j\text{=}25\,^{\circ}\text{C}, V_{DD}\text{=}50\text{V}, V_G\text{=}10\text{V}, \, R_G\text{=}25\Omega$



TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS (curves)

Figure 1. Safe operating area for TO-220/TO-263

10²

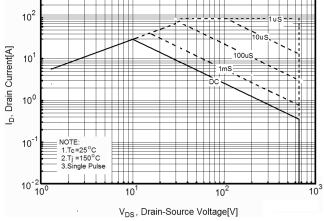


Figure 3. Source-Drain Diode Forward Voltage

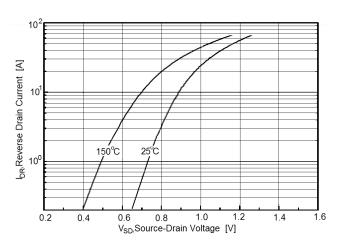
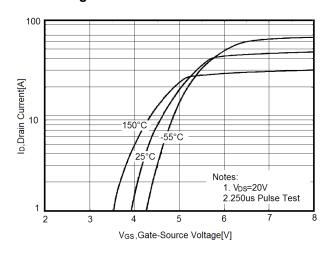


Figure 5. Transfer characteristics



10²
10¹
10¹
10¹
10¹
100us

Figure 2. Safe operating area for TO-220F

Figure 4. Output characteristics

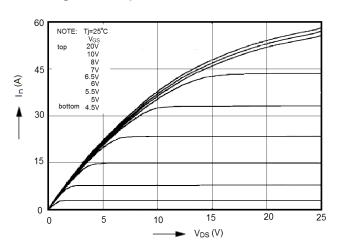


Figure 6. Static drain-source on resistance

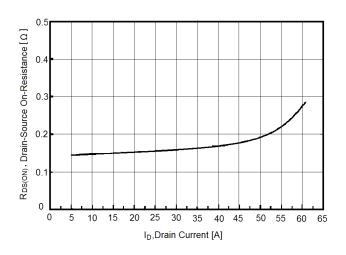




Figure 7. R_{DS(ON)} vs Junction Temperature

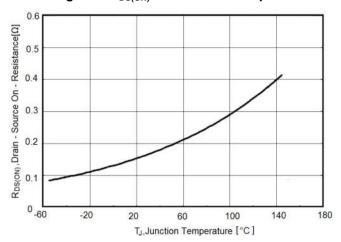


Figure 8. BV_{DSS} vs Junction Temperature

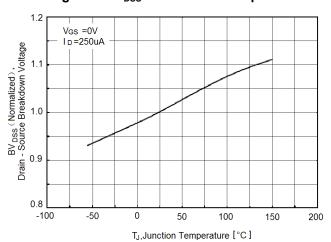


Figure 9. Maximum I_D vs Junction Temperature

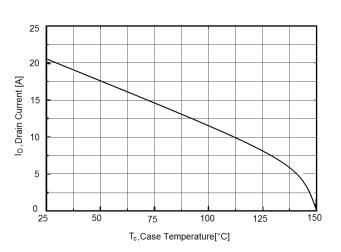


Figure 10. Transient Thermal Impedance for TO-220

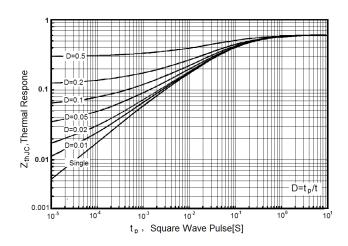


Figure 11. Transient Thermal Impedance for TO-220F

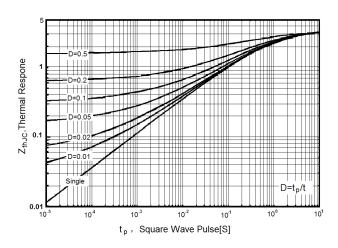


Figure 12. Gate charge waveforms

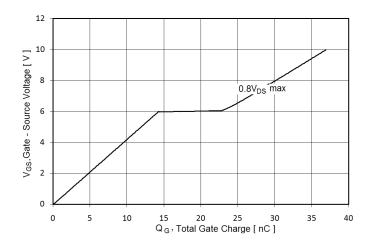
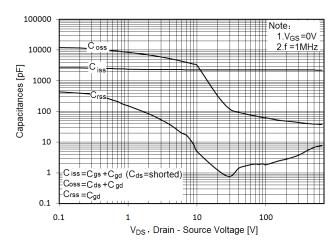




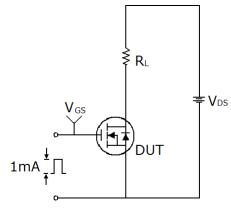
Figure 13. Capacitance

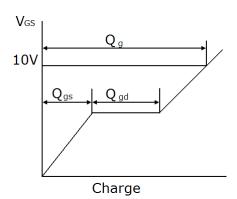




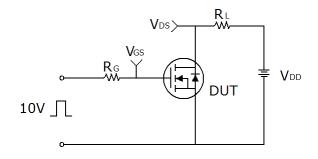
Test circuit

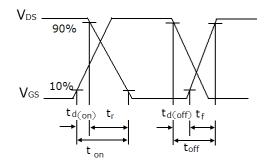
1) Gate charge test circuit & Waveform



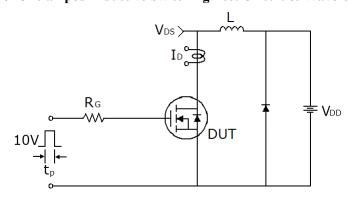


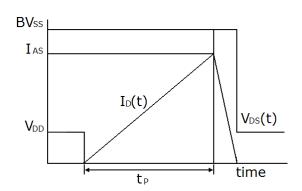
2) Switch Time Test Circuit:





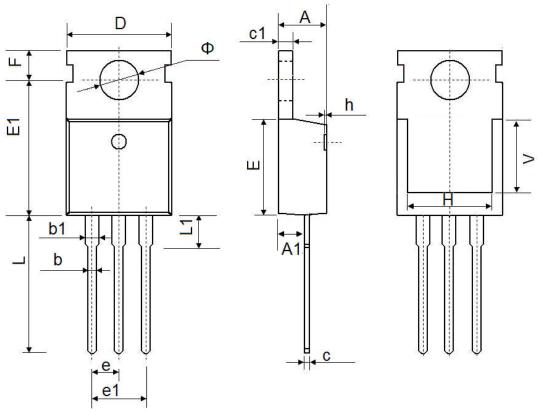
3) Unclamped Inductive Switching Test Circuit & Waveforms







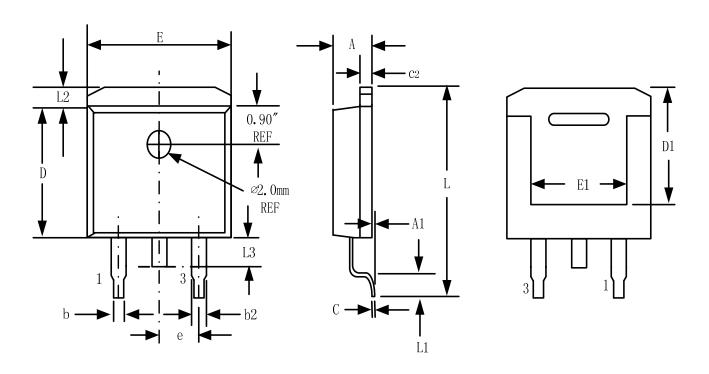
TO-220-3L-C Package Information



| Complete al | Dimensions I | n Millimeters | Dimensions | s In Inches |
|-------------|--------------|---------------|------------|-------------|
| Symbol | Min. | Max. | Min. | Max. |
| А | 4.400 | 4.600 | 0.173 | 0.181 |
| A1 | 2.250 | 2.550 | 0.089 | 0.100 |
| b | 0.710 | 0.910 | 0.028 | 0.036 |
| b1 | 1.170 | 1.370 | 0.046 | 0.054 |
| С | 0.330 | 0.650 | 0.013 | 0.026 |
| c1 | 1.200 | 1.400 | 0.047 | 0.055 |
| D | 9.910 | 10.250 | 0.390 | 0.404 |
| E | 8.9500 | 9.750 | 0.352 | 0.384 |
| E1 | 12.650 | 12.950 | 0.498 | 0.510 |
| е | 2.540 | TYP. | 0.100 | TYP. |
| e1 | 4.980 | 5.180 | 0.196 | 0.204 |
| F | 2.650 | 2.950 | 0.104 | 0.116 |
| Н | 7.900 | 8.100 | 0.311 | 0.319 |
| h | 0.000 | 0.300 | 0.000 | 0.012 |
| L | 12.900 | 13.400 | 0.508 | 0.528 |
| L1 | 2.850 | 3.250 | 0.112 | 0.128 |
| V | 7.500 REF. | | 0.295 | REF. |
| Ф | 3.400 | 3.800 | 0.134 | 0.150 |



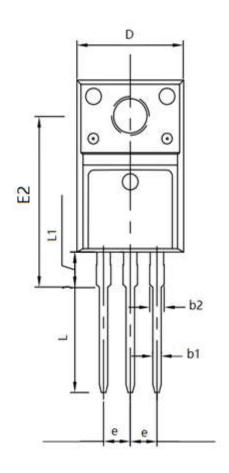
TO-263-3L Package Information

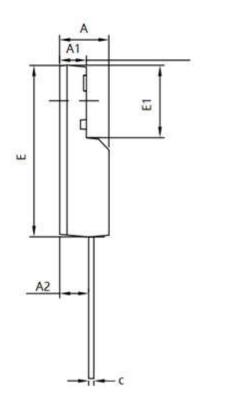


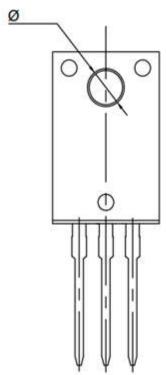
| Sumb al | Dimensions | In Millimeters | Dimensions In Inches | | |
|---------|------------|----------------|----------------------|-------|--|
| Symbol | Min. | Max. | Min. | Max. | |
| А | 4.32 | 4.57 | 0.170 | 0.180 | |
| A1 | - | 0.25 | | 0.010 | |
| b | 0.71 | 0.94 | 0.028 | 0.037 | |
| b2 | 1.15 | 1.40 | 0.045 | 0.055 | |
| С | 0.46 | 0.61 | 0.018 | 0.024 | |
| c2 | 1.22 | 1.40 | 0.048 | 0.055 | |
| D | 8.89 | 9.40 | 0.350 | 0.370 | |
| D1 | 8.01 | 8.23 | 0.315 | 0.324 | |
| Е | 10.04 | 10.28 | 0.395 | 0.405 | |
| E1 | 7.88 | 8.08 | 0.310 | 0.318 | |
| е | 2.54 | BSC | 0.100 | BSC | |
| L | 14.73 | 15.75 | 0.580 | 0.620 | |
| L1 | 2.29 | 2.79 | 0.090 | 0.110 | |
| L2 | 1.15 | 1.39 | 0.045 | 0.055 | |
| L3 | 1.27 | 1.77 | 0.050 | 0.070 | |



TO-220F Package Information







| Symbol | Dimensions | In Millimeters | Dimensions In Inches | | |
|--------|------------|----------------|----------------------|-------|--|
| | Min. | Max. | Min. | Max. | |
| Α | 4.500 | 4.900 | 0.177 | 0.193 | |
| A1 | 2.340 | 2.740 | 0.092 | 0.108 | |
| A2 | 2.560 | 2.960 | 0.101 | 0.117 | |
| b1 | 0.700 | 0.900 | 0.028 | 0.035 | |
| b2 | 1.180 | 1.580 | 0.046 | 0.062 | |
| С | 0.400 | 0.600 | 0.016 | 0.024 | |
| D | 9.960 | 10.360 | 0.392 | 0.408 | |
| E | 15.670 | 15.970 | 0.617 | 0.629 | |
| E1 | 6.500 | 6.900 | 0.256 | 0.272 | |
| E2 | 15.500 | 16.100 | 0.610 | 0.634 | |
| е | 2.540 |) TYP | 0.100 | TYP | |
| Ф | 3.080 | 3.280 | 0.121 | 0.129 | |
| L | 12.640 | 13.240 | 0.498 | 0.521 | |
| L1 | 3.030 | 3.430 | 0.119 | 0.135 | |



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